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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Obsolete |
| Core Processor | RL78 |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CSI, I ² C, LINbus, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 15 |
| Program Memory Size | 64KB (64K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 4K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V |
| Data Converters | A/D 6x8/10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 24-WFQFN Exposed Pad |
| Supplier Device Package | 24-HWQFN (4x4) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f1017edna-u0 |

Table 1-1. List of Ordering Part Numbers

(3/12)

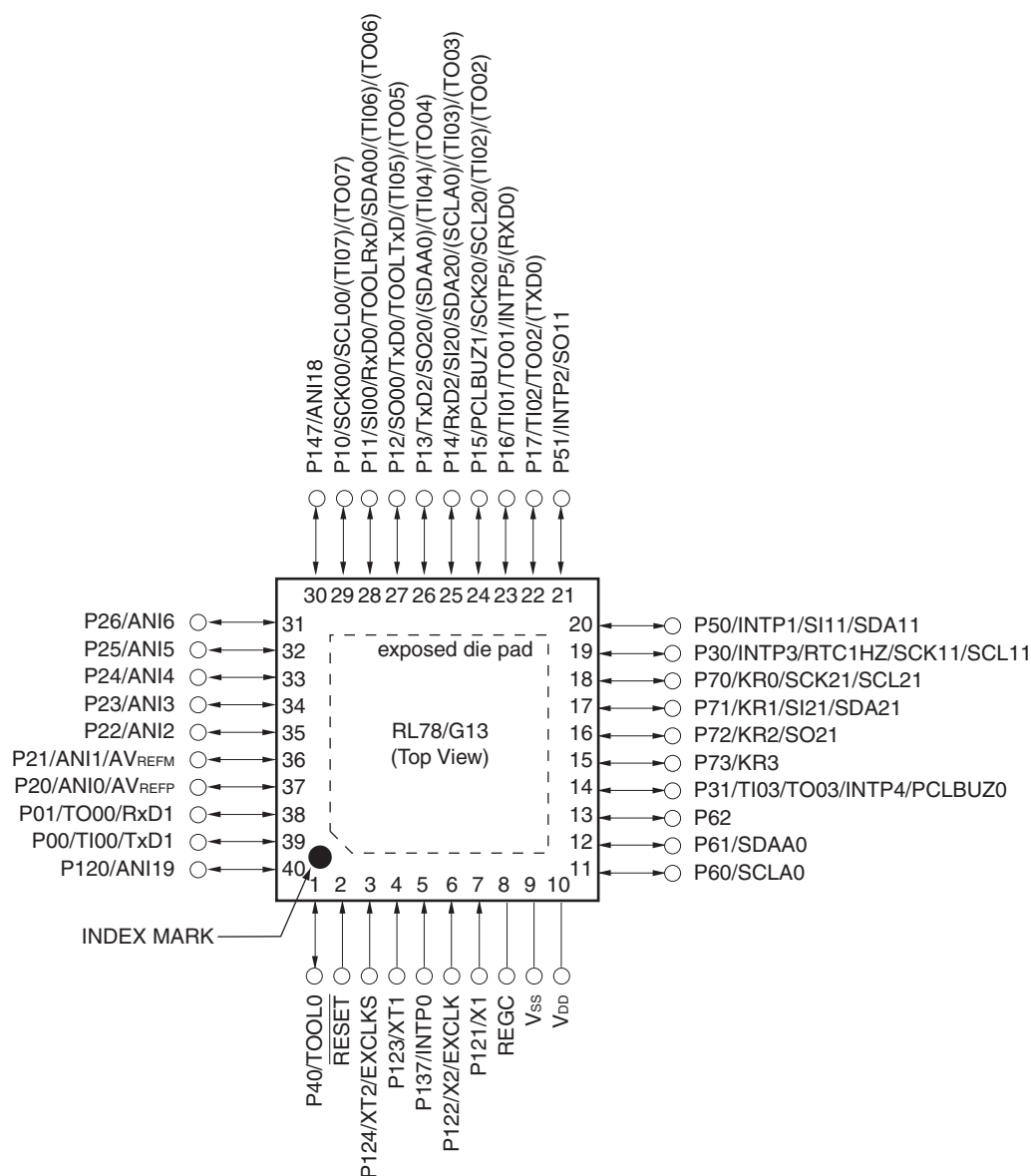
| Pin count | Package | Data flash | Fields of Application Note | Ordering Part Number |
|-----------|--|-------------|-------------------------------|--|
| 36 pins | 36-pin plastic WFLGA (4 × 4 mm, 0.5 mm pitch) | Mounted | A | R5F100CAALA#U0, R5F100CCALA#U0, R5F100CDALA#U0, R5F100CEALA#U0, R5F100CFALA#U0, R5F100CGALA#U0 R5F100CAALA#W0, R5F100CCALA#W0, R5F100CDALA#W0, R5F100CEALA#W0, R5F100CFALA#W0, R5F100CGALA#W0 R5F100CAGLA#U0, R5F100CCGLA#U0, R5F100CDGLA#U0, R5F100CEGLA#U0, R5F100CFGLA#U0, R5F100CGGLA#U0 R5F100CAGLA#W0, R5F100CCGLA#W0, R5F100CDGLA#W0, R5F100CEGLA#W0, R5F100CFGLA#W0, R5F100CGGLA#W0 |
| | | Not mounted | A | R5F101CAALA#U0, R5F101CCALA#U0, R5F101CDALA#U0, R5F101CEALA#U0, R5F101CFALA#U0, R5F101CGALA#U0 R5F101CAALA#W0, R5F101CCALA#W0, R5F101CDALA#W0, R5F101CEALA#W0, R5F101CFALA#W0, R5F101CGALA#W0 |
| 40 pins | 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch) | Mounted | A | R5F100EAANA#U0, R5F100ECANA#U0, R5F100EDANA#U0, R5F100EEANA#U0, R5F100EFANA#U0, R5F100EGANA#U0, R5F100EHANA#U0 R5F100EAANA#W0, R5F100ECANA#W0, R5F100EDANA#W0, R5F100EEANA#W0, R5F100EFANA#W0, R5F100EGANA#W0, R5F100EHANA#W0 R5F100EADNA#U0, R5F100ECDNA#U0, R5F100EDDNA#U0, R5F100EEDNA#U0, R5F100EFDNA#U0, R5F100EGDNA#U0, R5F100EHDNA#U0 R5F100EADNA#W0, R5F100ECDNA#W0, R5F100EDDNA#W0, R5F100EEDNA#W0, R5F100EFDNA#W0, R5F100EGDNA#W0, R5F100EHDNA#W0 R5F100EAGNA#U0, R5F100ECGNA#U0, R5F100EDGNA#U0, R5F100EEGNA#U0, R5F100EFGNA#U0, R5F100EGGNA#U0, R5F100EHGNA#U0 R5F100EAGNA#W0, R5F100ECGNA#W0, R5F100EDGNA#W0, R5F100EEGNA#W0, R5F100EFGNA#W0, R5F100EGGNA#W0, R5F100EHGNA#W0 |
| | | Not mounted | A | R5F101EAANA#U0, R5F101ECANA#U0, R5F101EDANA#U0, R5F101EEANA#U0, R5F101EFANA#U0, R5F101EGANA#U0, R5F101EHANA#U0 R5F101EAANA#W0, R5F101ECANA#W0, R5F101EDANA#W0, R5F101EEANA#W0, R5F101EFANA#W0, R5F101EGANA#W0, R5F101EHANA#W0 R5F101EADNA#U0, R5F101ECDNA#U0, R5F101EDDNA#U0, R5F101EEDNA#U0, R5F101EFDNA#U0, R5F101EGDNA#U0, R5F101EHDNA#U0 R5F101EADNA#W0, R5F101ECDNA#W0, R5F101EDDNA#W0, R5F101EEDNA#W0, R5F101EFDNA#W0, R5F101EGDNA#W0, R5F101EHDNA#W0 |

Note For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

1.3.7 40-pin products

- 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)

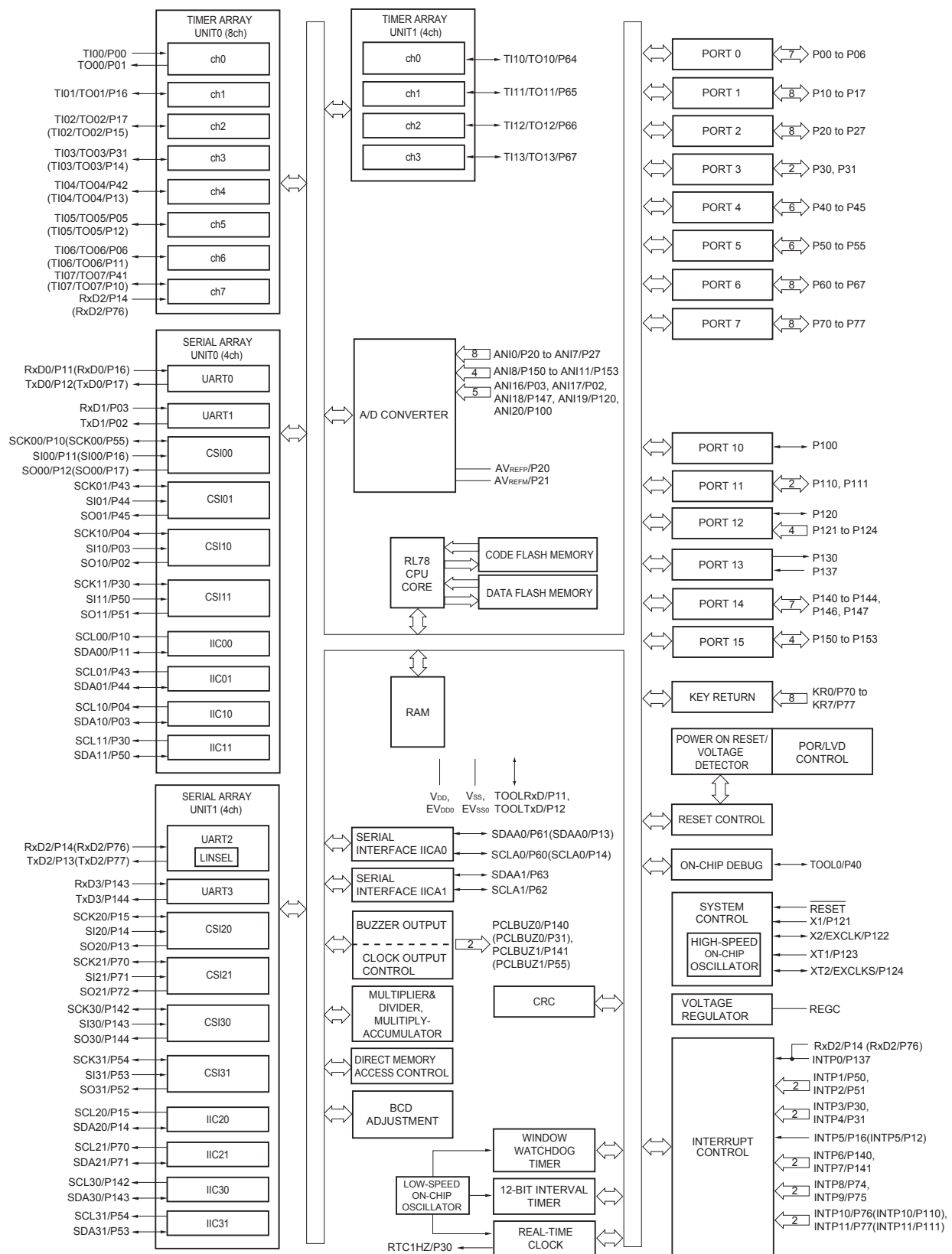


Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 μ F).

Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.
- It is recommended to connect an exposed die pad to Vss.

1.5.12 80-pin products



Remark Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

[40-pin, 44-pin, 48-pin, 52-pin, 64-pin products]

Caution This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.

(1/2)

| Item | | 40-pin | | 44-pin | | 48-pin | | 52-pin | | 64-pin | |
|------------------------------------|---|---|----------|--|----------|---|----------|---|----------|---|----------|
| | | R5F100Ex | R5F101Ex | R5F100Fx | R5F101Fx | R5F100Gx | R5F101Gx | R5F100Jx | R5F101Jx | R5F100Lx | R5F101Lx |
| Code flash memory (KB) | | 16 to 192 | | 16 to 512 | | 16 to 512 | | 32 to 512 | | 32 to 512 | |
| Data flash memory (KB) | | 4 to 8 | — | 4 to 8 | — | 4 to 8 | — | 4 to 8 | — | 4 to 8 | — |
| RAM (KB) | | 2 to 16 ^{Note1} | | 2 to 32 ^{Note1} | | 2 to 32 ^{Note1} | | 2 to 32 ^{Note1} | | 2 to 32 ^{Note1} | |
| Address space | | 1 MB | | | | | | | | | |
| Main system clock | High-speed system clock | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | |
| | High-speed on-chip oscillator | HS (High-speed main) mode: 1 to 32 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | |
| Subsystem clock | | XT1 (crystal) oscillation, external subsystem clock input (EXCLKS) 32.768 kHz | | | | | | | | | |
| Low-speed on-chip oscillator | | 15 kHz (TYP.) | | | | | | | | | |
| General-purpose registers | | (8-bit register × 8) × 4 banks | | | | | | | | | |
| Minimum instruction execution time | | 0.03125 μs (High-speed on-chip oscillator: f _{IH} = 32 MHz operation) | | | | | | | | | |
| | | 0.05 μs (High-speed system clock: f _{MX} = 20 MHz operation) | | | | | | | | | |
| | | 30.5 μs (Subsystem clock: f _{SUB} = 32.768 kHz operation) | | | | | | | | | |
| Instruction set | | <ul style="list-style-type: none">• Data transfer (8/16 bits)• Adder and subtractor/logical operation (8/16 bits)• Multiplication (8 bits × 8 bits)• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc. | | | | | | | | | |
| I/O port | Total | 36 | | 40 | | 44 | | 48 | | 58 | |
| | CMOS I/O | 28 (N-ch O.D. I/O [V _{DD} withstand voltage]: 10) | | 31 (N-ch O.D. I/O [V _{DD} withstand voltage]: 10) | | 34 (N-ch O.D. I/O [V _{DD} withstand voltage]: 11) | | 38 (N-ch O.D. I/O [V _{DD} withstand voltage]: 13) | | 48 (N-ch O.D. I/O [V _{DD} withstand voltage]: 15) | |
| | CMOS input | 5 | | 5 | | 5 | | 5 | | 5 | |
| | CMOS output | — | | — | | 1 | | 1 | | 1 | |
| | N-ch O.D. I/O (withstand voltage: 6 V) | 3 | | 4 | | 4 | | 4 | | 4 | |
| Timer | 16-bit timer | 8 channels | | | | | | | | | |
| | Watchdog timer | 1 channel | | | | | | | | | |
| | Real-time clock (RTC) | 1 channel | | | | | | | | | |
| | 12-bit interval timer (IT) | 1 channel | | | | | | | | | |
| | Timer output | 4 channels (PWM outputs: 3 ^{Note2}), 8 channels (PWM outputs: 7 ^{Note2, Note3}) | | 5 channels (PWM outputs: 4 ^{Note2}), 8 channels (PWM outputs: 7 ^{Note2}) ^{Note3} | | | | | | 8 channels (PWM outputs: 7 ^{Note2}) | |
| | RTC output | 1 channel • 1 Hz (subsystem clock: f _{SUB} = 32.768 kHz) | | | | | | | | | |

Notes 1. The flash library uses RAM in self-programming and rewriting of the data flash memory. The target products and start address of the RAM areas used by the flash library are shown below.

R5F100xD, R5F101xD (x = E to G, J, L): Start address FF300H

R5F100xE, R5F101xE (x = E to G, J, L): Start address FEF00H

R5F100xJ, R5F101xJ (x = F, G, J, L): Start address FAF00H

R5F100xL, R5F101xL (x = F, G, J, L): Start address F7F00H

For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.

2.1 Absolute Maximum Ratings

Absolute Maximum Ratings (T_A = 25°C) (1/2)

| Parameter | Symbols | Conditions | Ratings | Unit |
|------------------------|---------------------------------------|---|--|------|
| Supply voltage | V _{DD} | | -0.5 to +6.5 | V |
| | EV _{DD0} , EV _{DD1} | EV _{DD0} = EV _{DD1} | -0.5 to +6.5 | V |
| | EV _{SS0} , EV _{SS1} | EV _{SS0} = EV _{SS1} | -0.5 to +0.3 | V |
| REGC pin input voltage | V _{IREGC} | REGC | -0.3 to +2.8 and -0.3 to V _{DD} + 0.3 ^{Note 1} | V |
| Input voltage | V _{I1} | P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147 | -0.3 to EV _{DD0} + 0.3 and -0.3 to V _{DD} + 0.3 ^{Note 2} | V |
| | V _{I2} | P60 to P63 (N-ch open-drain) | -0.3 to +6.5 | V |
| | V _{I3} | P20 to P27, P121 to P124, P137, P150 to P156, EXCLK, EXCLKS, RESET | -0.3 to V _{DD} + 0.3 ^{Note 2} | V |
| Output voltage | V _{O1} | P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147 | -0.3 to EV _{DD0} + 0.3 and -0.3 to V _{DD} + 0.3 ^{Note 2} | V |
| | V _{O2} | P20 to P27, P150 to P156 | -0.3 to V _{DD} + 0.3 ^{Note 2} | V |
| Analog input voltage | V _{AI1} | ANI16 to ANI26 | -0.3 to EV _{DD0} + 0.3 and -0.3 to AV _{REF} (+) + 0.3 ^{Notes 2, 3} | V |
| | V _{AI2} | ANI0 to ANI14 | -0.3 to V _{DD} + 0.3 and -0.3 to AV _{REF} (+) + 0.3 ^{Notes 2, 3} | V |

Notes 1. Connect the REGC pin to V_{SS} via a capacitor (0.47 to 1 μF). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.

2. Must be 6.5 V or lower.

3. Do not exceed AV_{REF}(+) + 0.3 V in case of A/D conversion target pin.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

Remarks 1. Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

2. AV_{REF}(+) : + side reference voltage of the A/D converter.

3. V_{SS} : Reference voltage

2.2 Oscillator Characteristics

2.2.1 X1, XT1 oscillator characteristics

(T_A = -40 to +85°C, 1.6 V ≤ V_{DD} ≤ 5.5 V, V_{SS} = 0 V)

| Parameter | Resonator | Conditions | MIN. | TYP. | MAX. | Unit |
|---|---|---------------------------------|------|--------|------|------|
| X1 clock oscillation frequency (f _x) ^{Note} | Ceramic resonator/ crystal resonator | 2.7 V ≤ V _{DD} ≤ 5.5 V | 1.0 | | 20.0 | MHz |
| | | 2.4 V ≤ V _{DD} < 2.7 V | 1.0 | | 16.0 | MHz |
| | | 1.8 V ≤ V _{DD} < 2.4 V | 1.0 | | 8.0 | MHz |
| | | 1.6 V ≤ V _{DD} < 1.8 V | 1.0 | | 4.0 | MHz |
| XT1 clock oscillation frequency (f _x) ^{Note} | Crystal resonator | | 32 | 32.768 | 35 | kHz |

Note Indicates only permissible oscillator frequency ranges. Refer to AC Characteristics for instruction execution time. Request evaluation by the manufacturer of the oscillator circuit mounted on a board to check the oscillator characteristics.

Caution Since the CPU is started by the high-speed on-chip oscillator clock after a reset release, check the X1 clock oscillation stabilization time using the oscillation stabilization time counter status register (OSTC) by the user. Determine the oscillation stabilization time of the OSTC register and the oscillation stabilization time select register (OSTS) after sufficiently evaluating the oscillation stabilization time with the resonator to be used.

Remark When using the X1 oscillator and XT1 oscillator, refer to 5.4 System Clock Oscillator.

2.2.2 On-chip oscillator characteristics

(T_A = -40 to +85°C, 1.6 V ≤ V_{DD} ≤ 5.5 V, V_{SS} = 0 V)

| Oscillators | Parameters | Conditions | | MIN. | TYP. | MAX. | Unit |
|---|-----------------|---------------|---------------------------------|------|------|------|------|
| High-speed on-chip oscillator clock frequency ^{Notes 1, 2} | f _{IH} | | | 1 | | 32 | MHz |
| High-speed on-chip oscillator clock frequency accuracy | | -20 to +85 °C | 1.8 V ≤ V _{DD} ≤ 5.5 V | -1.0 | | +1.0 | % |
| | | | 1.6 V ≤ V _{DD} < 1.8 V | -5.0 | | +5.0 | % |
| | | -40 to -20 °C | 1.8 V ≤ V _{DD} ≤ 5.5 V | -1.5 | | +1.5 | % |
| | | | 1.6 V ≤ V _{DD} < 1.8 V | -5.5 | | +5.5 | % |
| Low-speed on-chip oscillator clock frequency | f _{IL} | | | | 15 | | kHz |
| Low-speed on-chip oscillator clock frequency accuracy | | | | -15 | | +15 | % |

Notes 1. High-speed on-chip oscillator frequency is selected by bits 0 to 3 of option byte (000C2H/010C2H) and bits 0 to 2 of HOCODIV register.

2. This indicates the oscillator characteristics only. Refer to AC Characteristics for instruction execution time.

(1) Flash ROM: 16 to 64 KB of 20- to 64-pin products

(T_A = -40 to +85°C, 1.6 V ≤ E_{VDD0} ≤ V_{DD} ≤ 5.5 V, V_{SS} = E_{VSS0} = 0 V) (2/2)

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit | |
|--------------------------|----------------------------|-----------------------------|---|---|-------------------------|------|------|------|------|----|
| Supply current Note 1 | I _{DD2} Note 2 | HALT mode | HS (high-speed main) mode Note 7 | f _{IH} = 32 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.54 | 1.63 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.54 | 1.63 | mA | |
| | | | | f _{IH} = 24 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.44 | 1.28 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.44 | 1.28 | mA | |
| | | | | f _{IH} = 16 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.40 | 1.00 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.40 | 1.00 | mA | |
| | | | LS (low-speed main) mode Note 7 | f _{IH} = 8 MHz ^{Note 4} | V _{DD} = 3.0 V | | 260 | 530 | μA | |
| | | | | | V _{DD} = 2.0 V | | 260 | 530 | μA | |
| | | | LV (low-voltage main) mode Note 7 | f _{IH} = 4 MHz ^{Note 4} | V _{DD} = 3.0 V | | 420 | 640 | μA | |
| | | | | | V _{DD} = 2.0 V | | 420 | 640 | μA | |
| | | | HS (high-speed main) mode Note 7 | f _{MX} = 20 MHz ^{Note 3} , V _{DD} = 5.0 V | Square wave input | | 0.28 | 1.00 | mA | |
| | | | | | Resonator connection | | 0.45 | 1.17 | mA | |
| | | | | f _{MX} = 20 MHz ^{Note 3} , V _{DD} = 3.0 V | Square wave input | | 0.28 | 1.00 | mA | |
| | | | | | Resonator connection | | 0.45 | 1.17 | mA | |
| | | | | f _{MX} = 10 MHz ^{Note 3} , V _{DD} = 5.0 V | Square wave input | | 0.19 | 0.60 | mA | |
| | | | | | Resonator connection | | 0.26 | 0.67 | mA | |
| | | | | f _{MX} = 10 MHz ^{Note 3} , V _{DD} = 3.0 V | Square wave input | | 0.19 | 0.60 | mA | |
| | | | | | Resonator connection | | 0.26 | 0.67 | mA | |
| | | | LS (low-speed main) mode Note 7 | f _{MX} = 8 MHz ^{Note 3} , V _{DD} = 3.0 V | Square wave input | | 95 | 330 | μA | |
| | | | | | Resonator connection | | 145 | 380 | μA | |
| | | | | f _{MX} = 8 MHz ^{Note 3} , V _{DD} = 2.0 V | Square wave input | | 95 | 330 | μA | |
| | | | | | Resonator connection | | 145 | 380 | μA | |
| | | | Subsystem clock operation | f _{SUB} = 32.768 kHz ^{Note 5} , T _A = −40°C | Square wave input | | 0.25 | 0.57 | μA | |
| | | | | | Resonator connection | | 0.44 | 0.76 | μA | |
| | | | | f _{SUB} = 32.768 kHz ^{Note 5} , T _A = +25°C | Square wave input | | 0.30 | 0.57 | μA | |
| | | | | | Resonator connection | | 0.49 | 0.76 | μA | |
| | | | | f _{SUB} = 32.768 kHz ^{Note 5} , T _A = +50°C | Square wave input | | 0.37 | 1.17 | μA | |
| | | | | | Resonator connection | | 0.56 | 1.36 | μA | |
| | | | | f _{SUB} = 32.768 kHz ^{Note 5} , T _A = +70°C | Square wave input | | 0.53 | 1.97 | μA | |
| | | | | | Resonator connection | | 0.72 | 2.16 | μA | |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} , T _A = +85°C | Square wave input | | 0.82 | 3.37 | μA | | |
| | | | | Resonator connection | | 1.01 | 3.56 | μA | | |
| | I _{DD3} Note 6 | STOP mode ^{Note 8} | T _A = −40°C | | | | | 0.18 | 0.50 | μA |
| | | | T _A = +25°C | | | | | 0.23 | 0.50 | μA |
| | | | T _A = +50°C | | | | | 0.30 | 1.10 | μA |
| | | | T _A = +70°C | | | | | 0.46 | 1.90 | μA |
| | | | T _A = +85°C | | | | | 0.75 | 3.30 | μA |

(Notes and Remarks are listed on the next page.)

6. Current flowing only to the A/D converter. The supply current of the RL78 microcontrollers is the sum of I_{DD1} or I_{DD2} and I_{ADC} when the A/D converter operates in an operation mode or the HALT mode.
7. Current flowing only to the LVD circuit. The supply current of the RL78 microcontrollers is the sum of I_{DD1} , I_{DD2} or I_{DD3} and I_{LVD} when the LVD circuit is in operation.
8. Current flowing only during data flash rewrite.
9. Current flowing only during self programming.
10. For shift time to the SNOOZE mode, see **18.3.3 SNOOZE mode**.

- Remarks**
1. f_{IL} : Low-speed on-chip oscillator clock frequency
 2. f_{SUB} : Subsystem clock frequency (XT1 clock oscillation frequency)
 3. f_{CLK} : CPU/peripheral hardware clock frequency
 4. Temperature condition of the TYP. value is $T_A = 25^{\circ}\text{C}$

- Remarks 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3),
g: PIM and POM numbers (g = 0, 1, 4, 5, 8, 14)
- 2.** f_{MCK}: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,
n: Channel number (mn = 00 to 03, 10 to 13))

(4) During communication at same potential (CSI mode) (slave mode, SCKp... external clock input) (1/2)
(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

| Parameter | Symbol | Conditions | | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|--|--|-----------------------------------|---------------------------|--------------------------------|------|--------------------------------|------|--------------------------------|------|------|
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time <small>Note 5</small> | t _{KCY2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | 20 MHz < f _{MCK} | 8/f _{MCK} | | — | | — | | ns |
| | | | f _{MCK} ≤ 20 MHz | 6/f _{MCK} | | 6/f _{MCK} | | 6/f _{MCK} | | ns |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 16 MHz < f _{MCK} | 8/f _{MCK} | | — | | — | | ns |
| | | | f _{MCK} ≤ 16 MHz | 6/f _{MCK} | | 6/f _{MCK} | | 6/f _{MCK} | | ns |
| | | 2.4 V ≤ EV _{DD0} ≤ 5.5 V | | 6/f _{MCK} and 500 | | 6/f _{MCK} and 500 | | 6/f _{MCK} and 500 | | ns |
| | | 1.8 V ≤ EV _{DD0} ≤ 5.5 V | | 6/f _{MCK} and 750 | | 6/f _{MCK} and 750 | | 6/f _{MCK} and 750 | | ns |
| | | 1.7 V ≤ EV _{DD0} ≤ 5.5 V | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | | ns |
| | | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | — | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | | ns |
| SCKp high-/low-level width | t _{KH2} , t _{KL2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 7 | | t _{KCY2} /2 – 7 | | t _{KCY2} /2 – 7 | | ns |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 8 | | t _{KCY2} /2 – 8 | | t _{KCY2} /2 – 8 | | ns |
| | | 1.8 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 18 | | t _{KCY2} /2 – 18 | | t _{KCY2} /2 – 18 | | ns |
| | | 1.7 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | | ns |
| | | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | — | | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | | ns |

(Notes, Caution, and Remarks are listed on the next page.)

(9) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (slave mode, SCKp... external clock input)

(T_A = -40 to +85°C, 1.8 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V) (1/2)

| Parameter | Symbol | Conditions | | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|-----------------------------------|-------------------|--|------------------------------------|---------------------------|------|--------------------------|------|----------------------------|------|------|
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time ^{Note 1} | t _{KCY2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V | 24 MHz < f _{MCK} | 14/ f _{MCK} | | — | | — | | ns |
| | | | 20 MHz < f _{MCK} ≤ 24 MHz | 12/ f _{MCK} | | — | | — | | ns |
| | | | 8 MHz < f _{MCK} ≤ 20 MHz | 10/ f _{MCK} | | — | | — | | ns |
| | | | 4 MHz < f _{MCK} ≤ 8 MHz | 8/f _{MCK} | | 16/ f _{MCK} | | — | | ns |
| | | | f _{MCK} ≤ 4 MHz | 6/f _{MCK} | | 10/ f _{MCK} | | 10/ f _{MCK} | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V | 24 MHz < f _{MCK} | 20/ f _{MCK} | | — | | — | | ns |
| | | | 20 MHz < f _{MCK} ≤ 24 MHz | 16/ f _{MCK} | | — | | — | | ns |
| | | | 16 MHz < f _{MCK} ≤ 20 MHz | 14/ f _{MCK} | | — | | — | | ns |
| | | | 8 MHz < f _{MCK} ≤ 16 MHz | 12/ f _{MCK} | | — | | — | | ns |
| | | | 4 MHz < f _{MCK} ≤ 8 MHz | 8/f _{MCK} | | 16/ f _{MCK} | | — | | ns |
| | | | f _{MCK} ≤ 4 MHz | 6/f _{MCK} | | 10/ f _{MCK} | | 10/ f _{MCK} | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} | 24 MHz < f _{MCK} | 48/ f _{MCK} | | — | | — | | ns |
| | | | 20 MHz < f _{MCK} ≤ 24 MHz | 36/ f _{MCK} | | — | | — | | ns |
| | | | 16 MHz < f _{MCK} ≤ 20 MHz | 32/ f _{MCK} | | — | | — | | ns |
| | | | 8 MHz < f _{MCK} ≤ 16 MHz | 26/ f _{MCK} | | — | | — | | ns |
| | | | 4 MHz < f _{MCK} ≤ 8 MHz | 16/ f _{MCK} | | 16/ f _{MCK} | | — | | ns |
| | | | f _{MCK} ≤ 4 MHz | 10/ f _{MCK} | | 10/ f _{MCK} | | 10/ f _{MCK} | | ns |

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)

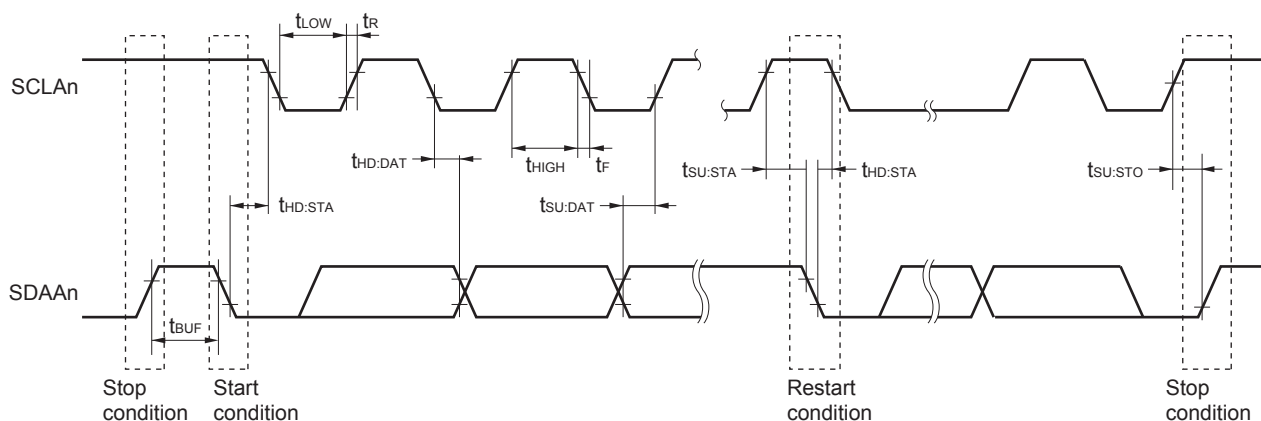
(3) I²C fast mode plus(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

| Parameter | Symbol | Conditions | | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|---|---------------------|--|-----------------------------------|---------------------------|------|--------------------------|------|----------------------------|------|------|
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCLA0 clock frequency | f _{SCL} | Fast mode plus: f _{CLK} ≥ 10 MHz | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 0 | 1000 | — | — | — | — | kHz |
| Setup time of restart condition | t _{SU:STA} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.26 | | — | — | — | — | μs |
| Hold time ^{Note 1} | t _{HD:STA} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.26 | | — | — | — | — | μs |
| Hold time when SCLA0 = "L" | t _{LOW} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.5 | | — | — | — | — | μs |
| Hold time when SCLA0 = "H" | t _{HIGH} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.26 | | — | — | — | — | μs |
| Data setup time (reception) | t _{SU:DAT} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 50 | | — | — | — | — | μs |
| Data hold time (transmission) ^{Note 2} | t _{HD:DAT} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0 | 0.45 | — | — | — | — | μs |
| Setup time of stop condition | t _{SU:STO} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.26 | | — | — | — | — | μs |
| Bus-free time | t _{BUF} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | 0.5 | | — | — | — | — | μs |

Notes 1. The first clock pulse is generated after this period when the start/restart condition is detected.<R> 2. The maximum value (MAX.) of t_{HD:DAT} is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (I_{OH1}, I_{OL1}, V_{OH1}, V_{OL1}) must satisfy the values in the redirect destination.

Remark The maximum value of C_b (communication line capacitance) and the value of R_b (communication line pull-up resistor) at that time in each mode are as follows.

Fast mode plus: C_b = 120 pF, R_b = 1.1 kΩ**I²C serial transfer timing****Remark** n = 0, 1

(3) When reference voltage (+) = V_{DD} (ADREFP1 = 0, ADREFP0 = 0), reference voltage (–) = V_{SS} (ADREFM = 0), target pin : ANI0 to ANI14, ANI16 to ANI26, internal reference voltage, and temperature sensor output voltage

(T_A = –40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V, Reference voltage (+) = V_{DD}, Reference voltage (–) = V_{SS})

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|--|-------------------|--|--|--------|------|-------------------|------|
| Resolution | RES | | | 8 | | 10 | bit |
| Overall error ^{Note 1} | AINL | 10-bit resolution | 1.8 V ≤ V _{DD} ≤ 5.5 V | | 1.2 | ±7.0 | LSB |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V <small>Note 3</small> | | 1.2 | ±10.5 | LSB |
| Conversion time | t _{CONV} | 10-bit resolution Target pin: ANI0 to ANI14, ANI16 to ANI26 | 3.6 V ≤ V _{DD} ≤ 5.5 V | 2.125 | | 39 | μs |
| | | | 2.7 V ≤ V _{DD} ≤ 5.5 V | 3.1875 | | 39 | μs |
| | | | 1.8 V ≤ V _{DD} ≤ 5.5 V | 17 | | 39 | μs |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V | 57 | | 95 | μs |
| Conversion time | t _{CONV} | 10-bit resolution Target pin: Internal reference voltage, and temperature sensor output voltage (HS (high-speed main) mode) | 3.6 V ≤ V _{DD} ≤ 5.5 V | 2.375 | | 39 | μs |
| | | | 2.7 V ≤ V _{DD} ≤ 5.5 V | 3.5625 | | 39 | μs |
| | | | 2.4 V ≤ V _{DD} ≤ 5.5 V | 17 | | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | E _{ZS} | 10-bit resolution | 1.8 V ≤ V _{DD} ≤ 5.5 V | | | ±0.60 | %FSR |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V <small>Note 3</small> | | | ±0.85 | %FSR |
| Full-scale error ^{Notes 1, 2} | E _{FS} | 10-bit resolution | 1.8 V ≤ V _{DD} ≤ 5.5 V | | | ±0.60 | %FSR |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V <small>Note 3</small> | | | ±0.85 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 10-bit resolution | 1.8 V ≤ V _{DD} ≤ 5.5 V | | | ±4.0 | LSB |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V <small>Note 3</small> | | | ±6.5 | LSB |
| Differential linearity error ^{Note 1} | DLE | 10-bit resolution | 1.8 V ≤ V _{DD} ≤ 5.5 V | | | ±2.0 | LSB |
| | | | 1.6 V ≤ V _{DD} ≤ 5.5 V <small>Note 3</small> | | | ±2.5 | LSB |
| Analog input voltage | V _{AIN} | ANI0 to ANI14 | 0 | | | V _{DD} | V |
| | | ANI16 to ANI26 | 0 | | | EV _{DD0} | V |
| | | Internal reference voltage (2.4 V ≤ V _{DD} ≤ 5.5 V, HS (high-speed main) mode) | V _{BGR} ^{Note 4} | | | | V |
| | | Temperature sensor output voltage (2.4 V ≤ V _{DD} ≤ 5.5 V, HS (high-speed main) mode) | V _{TMPS25} ^{Note 4} | | | | V |

Notes 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. When the conversion time is set to 57 μs (min.) and 95 μs (max.).

4. Refer to 2.6.2 Temperature sensor/internal reference voltage characteristics.

(4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (-) = AV_{REFM}/ANI1 (ADREFM = 1), target pin : ANI0, ANI2 to ANI14, ANI16 to ANI26

(T_A = -40 to +85°C, 2.4 V ≤ V_{DD} ≤ 5.5 V, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD}, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V, Reference voltage (+) = V_{BGR}^{Note 3}, Reference voltage (-) = AV_{REFM} = 0 V^{Note 4}, HS (high-speed main) mode)

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|--|-------------------|------------------|---------------------------------|------|------|------------------------------------|------|
| Resolution | RES | | | 8 | | | bit |
| Conversion time | t _{CONV} | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | 17 | | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | E _{zs} | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±0.60 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±2.0 | LSB |
| Differential linearity error ^{Note 1} | DLE | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±1.0 | LSB |
| Analog input voltage | V _{AIN} | | | 0 | | V _{BGR} ^{Note 3} | V |

Notes 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. Refer to **2.6.2 Temperature sensor/internal reference voltage characteristics**.

4. When reference voltage (-) = V_{SS}, the MAX. values are as follows.

Zero-scale error: Add ±0.35%FSR to the MAX. value when reference voltage (-) = AV_{REFM}.

Integral linearity error: Add ±0.5 LSB to the MAX. value when reference voltage (-) = AV_{REFM}.

Differential linearity error: Add ±0.2 LSB to the MAX. value when reference voltage (-) = AV_{REFM}.

3. ELECTRICAL SPECIFICATIONS (G: INDUSTRIAL APPLICATIONS $T_A = -40$ to $+105^\circ\text{C}$)

This chapter describes the following electrical specifications.

Target products G: Industrial applications $T_A = -40$ to $+105^\circ\text{C}$
R5F100xxGxx

- Cautions**
1. The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.
 2. With products not provided with an EV_{DD0} , EV_{DD1} , EV_{SS0} , or EV_{SS1} pin, replace EV_{DD0} and EV_{DD1} with V_{DD} , or replace EV_{SS0} and EV_{SS1} with V_{SS} .
 3. The pins mounted depend on the product. Refer to 2.1 Port Function to 2.2.1 Functions for each product.
 4. Please contact Renesas Electronics sales office for derating of operation under $T_A = +85^\circ\text{C}$ to $+105^\circ\text{C}$. Derating is the systematic reduction of load for the sake of improved reliability.

Remark When RL78/G13 is used in the range of $T_A = -40$ to $+85^\circ\text{C}$, see **CHAPTER 2 ELECTRICAL SPECIFICATIONS ($T_A = -40$ to $+85^\circ\text{C}$)**.

There are following differences between the products "G: Industrial applications ($T_A = -40$ to $+105^\circ\text{C}$)" and the products "A: Consumer applications, and D: Industrial applications".

| Parameter | Application | |
|--|--|---|
| | A: Consumer applications, D: Industrial applications | G: Industrial applications |
| Operating ambient temperature | $T_A = -40$ to $+85^\circ\text{C}$ | $T_A = -40$ to $+105^\circ\text{C}$ |
| Operating mode Operating voltage range | HS (high-speed main) mode: $2.7\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 32 MHz $2.4\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 16 MHz LS (low-speed main) mode: $1.8\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 8 MHz LV (low-voltage main) mode: $1.6\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 4 MHz | HS (high-speed main) mode only: $2.7\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 32 MHz $2.4\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}@1\text{ MHz}$ to 16 MHz |
| High-speed on-chip oscillator clock accuracy | $1.8\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$ $\pm 1.0\% @ T_A = -20$ to $+85^\circ\text{C}$ $\pm 1.5\% @ T_A = -40$ to -20°C $1.6\text{ V} \leq V_{\text{DD}} < 1.8\text{ V}$ $\pm 5.0\% @ T_A = -20$ to $+85^\circ\text{C}$ $\pm 5.5\% @ T_A = -40$ to -20°C | $2.4\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$ $\pm 2.0\% @ T_A = +85$ to $+105^\circ\text{C}$ $\pm 1.0\% @ T_A = -20$ to $+85^\circ\text{C}$ $\pm 1.5\% @ T_A = -40$ to -20°C |
| Serial array unit | UART CSI: $f_{\text{CLK}}/2$ (supporting 16 Mbps), $f_{\text{CLK}}/4$ Simplified I ² C communication | UART CSI: $f_{\text{CLK}}/4$ Simplified I ² C communication |
| IICA | Normal mode Fast mode Fast mode plus | Normal mode Fast mode |
| Voltage detector | Rise detection voltage: 1.67 V to 4.06 V (14 levels) Fall detection voltage: 1.63 V to 3.98 V (14 levels) | Rise detection voltage: 2.61 V to 4.06 V (8 levels) Fall detection voltage: 2.55 V to 3.98 V (8 levels) |

(Remark is listed on the next page.)

(1) Flash ROM: 16 to 64 KB of 20- to 64-pin products**($T_A = -40$ to $+105^{\circ}\text{C}$, $2.4\text{ V} \leq \text{EV}_{\text{DD0}} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$, $\text{V}_{\text{SS}} = \text{EV}_{\text{SS0}} = 0\text{ V}$) (2/2)**

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit | |
|--------------------------|------------------------------------|-----------------------------|--|---|---|----------------------|-------|------|-------|----|
| Supply current Note 1 | I _{DD2} Note 2 | HALT mode | HS (high-speed main) mode Note 7 | f _{IH} = 32 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.54 | 2.90 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.54 | 2.90 | mA | |
| | | | | f _{IH} = 24 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.44 | 2.30 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.44 | 2.30 | mA | |
| | | | | f _{IH} = 16 MHz ^{Note 4} | V _{DD} = 5.0 V | | 0.40 | 1.70 | mA | |
| | | | | | V _{DD} = 3.0 V | | 0.40 | 1.70 | mA | |
| | | | HS (high-speed main) mode Note 7 | f _{MX} = 20 MHz ^{Note 3} , V _{DD} = 5.0 V | Square wave input | | 0.28 | 1.90 | mA | |
| | | | | | Resonator connection | | 0.45 | 2.00 | mA | |
| | | | | f _{MX} = 20 MHz ^{Note 3} , V _{DD} = 3.0 V | Square wave input | | 0.28 | 1.90 | mA | |
| | | | | | Resonator connection | | 0.45 | 2.00 | mA | |
| | | | | f _{MX} = 10 MHz ^{Note 3} , V _{DD} = 5.0 V | Square wave input | | 0.19 | 1.02 | mA | |
| | | | | | Resonator connection | | 0.26 | 1.10 | mA | |
| | | | | f _{MX} = 10 MHz ^{Note 3} , V _{DD} = 3.0 V | Square wave input | | 0.19 | 1.02 | mA | |
| | | | | | Resonator connection | | 0.26 | 1.10 | mA | |
| | | | | Subsystem clock operation | f _{SUB} = 32.768 kHz ^{Note 5} T _A = −40°C | Square wave input | | 0.25 | 0.57 | μA |
| | | | | | | Resonator connection | | 0.44 | 0.76 | μA |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} T _A = +25°C | | Square wave input | | 0.30 | 0.57 | μA | |
| | | | | | Resonator connection | | 0.49 | 0.76 | μA | |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} T _A = +50°C | | Square wave input | | 0.37 | 1.17 | μA | |
| | | | | | Resonator connection | | 0.56 | 1.36 | μA | |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} T _A = +70°C | | Square wave input | | 0.53 | 1.97 | μA | |
| | | | | | Resonator connection | | 0.72 | 2.16 | μA | |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} T _A = +85°C | | Square wave input | | 0.82 | 3.37 | μA | |
| | | | | | Resonator connection | | 1.01 | 3.56 | μA | |
| | | | f _{SUB} = 32.768 kHz ^{Note 5} T _A = +105°C | Square wave input | | 3.01 | 15.37 | μA | | |
| | | | | Resonator connection | | 3.20 | 15.56 | μA | | |
| | I _{DD3} ^{Note 6} | STOP mode ^{Note 8} | T _A = −40°C | | | | | 0.18 | 0.50 | μA |
| | | | T _A = +25°C | | | | | 0.23 | 0.50 | μA |
| | | | T _A = +50°C | | | | | 0.30 | 1.10 | μA |
| | | | T _A = +70°C | | | | | 0.46 | 1.90 | μA |
| | | | T _A = +85°C | | | | | 0.75 | 3.30 | μA |
| | | | T _A = +105°C | | | | | 2.94 | 15.30 | μA |

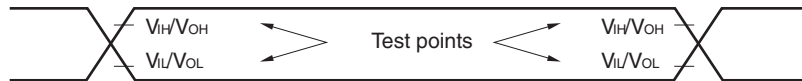
(Notes and Remarks are listed on the next page.)

- Notes**
1. Total current flowing into V_{DD} and EV_{DD0} , including the input leakage current flowing when the level of the input pin is fixed to V_{DD} , EV_{DD0} or V_{SS} , EV_{SS0} . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
 2. During HALT instruction execution by flash memory.
 3. When high-speed on-chip oscillator and subsystem clock are stopped.
 4. When high-speed system clock and subsystem clock are stopped.
 5. When high-speed on-chip oscillator and high-speed system clock are stopped. When $RTCLPC = 1$ and setting ultra-low current consumption ($AMPHS1 = 1$). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }32\text{ MHz}$
 $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }16\text{ MHz}$
 8. Regarding the value for current operate the subsystem clock in STOP mode, refer to that in HALT mode.

- Remarks**
1. f_{MX} : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 2. f_{IH} : High-speed on-chip oscillator clock frequency
 3. f_{SUB} : Subsystem clock frequency (XT1 clock oscillation frequency)
 4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is $T_A = 25^{\circ}\text{C}$

3.5 Peripheral Functions Characteristics

AC Timing Test Points



3.5.1 Serial array unit

(1) During communication at same potential (UART mode)

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq E_{VDD0} = E_{VDD1} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = E_{VSS0} = E_{VSS1} = 0\text{ V}$)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | Unit |
|---------------------------------|--------|---|---------------------------|--------------------------------|------|
| | | | MIN. | MAX. | |
| Transfer rate ^{Note 1} | | Theoretical value of the maximum transfer rate $f_{CLK} = 32\text{ MHz}$, $f_{MCK} = f_{CLK}$ | | $f_{MCK}/12$ ^{Note 2} | bps |
| | | | | 2.6 | Mbps |

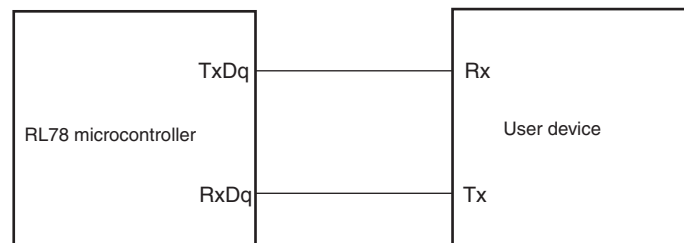
Notes 1. Transfer rate in the SNOOZE mode is 4800 bps only.

2. The following conditions are required for low voltage interface when $E_{VDD0} < V_{DD}$.

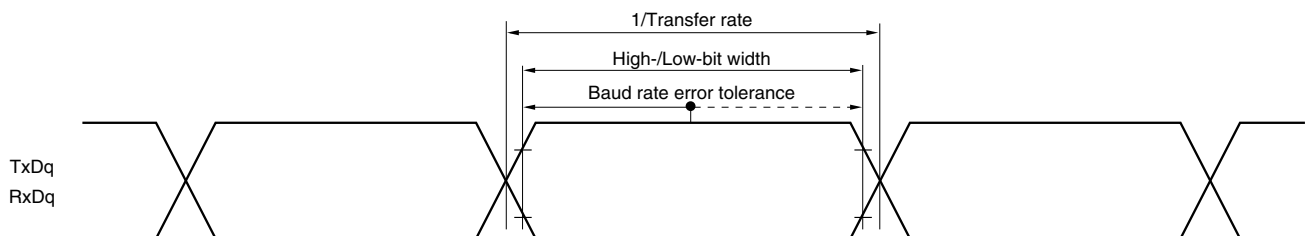
$2.4\text{ V} \leq E_{VDD0} < 2.7\text{ V}$: MAX. 1.3 Mbps

Caution Select the normal input buffer for the RxDq pin and the normal output mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg).

UART mode connection diagram (during communication at same potential)



UART mode bit width (during communication at same potential) (reference)



Remarks 1. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)

2. f_{MCK} : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

3.5.2 Serial interface IICA

(TA = -40 to +105°C, 2.4 V ≤ EVDD0 = EVDD1 ≤ VDD ≤ 5.5 V, VSS = EVSS0 = EVSS1 = 0 V)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | | | Unit |
|---|---------------------|---|---------------------------|------|-----------|------|------|
| | | | Standard Mode | | Fast Mode | | |
| | | | MIN. | MAX. | MIN. | MAX. | |
| SCLA0 clock frequency | f _{SCL} | Fast mode: f _{CLK} ≥ 3.5 MHz | – | – | 0 | 400 | kHz |
| | | Standard mode: f _{CLK} ≥ 1 MHz | 0 | 100 | – | – | kHz |
| Setup time of restart condition | t _{SU:STA} | | 4.7 | | 0.6 | | μs |
| Hold time ^{Note 1} | t _{HD:STA} | | 4.0 | | 0.6 | | μs |
| Hold time when SCLA0 = “L” | t _{LOW} | | 4.7 | | 1.3 | | μs |
| Hold time when SCLA0 = “H” | t _{HIGH} | | 4.0 | | 0.6 | | μs |
| Data setup time (reception) | t _{SU:DAT} | | 250 | | 100 | | ns |
| Data hold time (transmission) ^{Note 2} | t _{HD:DAT} | | 0 | 3.45 | 0 | 0.9 | μs |
| Setup time of stop condition | t _{SU:STO} | | 4.0 | | 0.6 | | μs |
| Bus-free time | t _{BUF} | | 4.7 | | 1.3 | | μs |

Notes 1. The first clock pulse is generated after this period when the start/restart condition is detected.

<R> 2. The maximum value (MAX.) of tHD:DAT is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

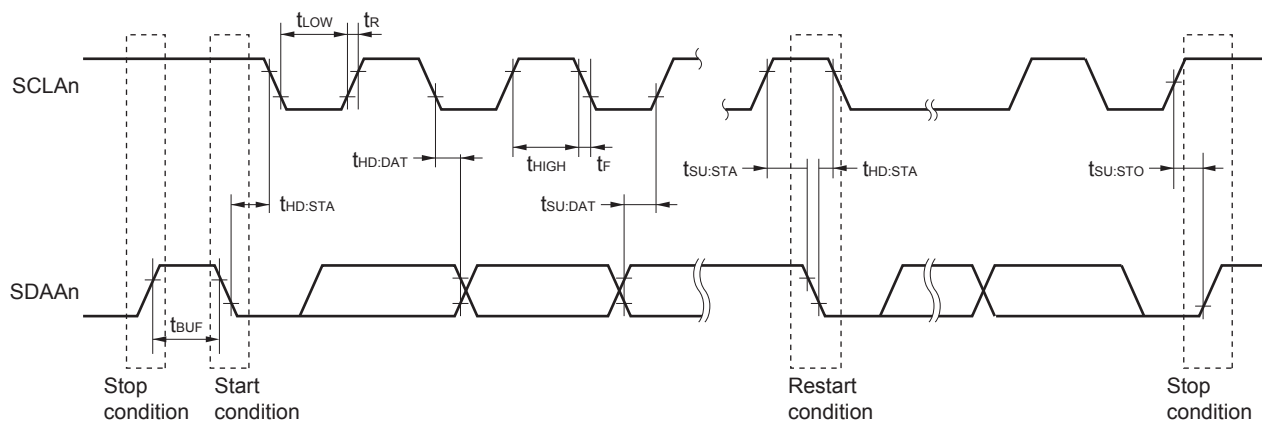
Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (IOH1, IOL1, VOH1, VOL1) must satisfy the values in the redirect destination.

Remark The maximum value of Cb (communication line capacitance) and the value of Rb (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode: Cb = 400 pF, Rb = 2.7 kΩ

Fast mode: Cb = 320 pF, Rb = 1.1 kΩ

IICA serial transfer timing

**Remark** n = 0, 1

3.8 Flash Memory Programming Characteristics

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = 0\text{ V}$)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|---|-------------------|---|---------|-----------|------|-------|
| CPU/peripheral hardware clock frequency | f _{CLK} | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 1 | | 32 | MHz |
| Number of code flash rewrites <small>Notes 1,2,3</small> | C _{enwr} | Retained for 20 years $T_A = 85^\circ\text{C}$ <small>Note 4</small> | 1,000 | | | Times |
| Number of data flash rewrites <small>Notes 1,2,3</small> | | Retained for 1 years $T_A = 25^\circ\text{C}$ | | 1,000,000 | | |
| | | Retained for 5 years $T_A = 85^\circ\text{C}$ <small>Note 4</small> | 100,000 | | | |
| | | Retained for 20 years $T_A = 85^\circ\text{C}$ <small>Note 4</small> | 10,000 | | | |

- Notes**
- 1 erase + 1 write after the erase is regarded as 1 rewrite. The retaining years are until next rewrite after the rewrite.
 2. When using flash memory programmer and Renesas Electronics self programming library.
 3. These are the characteristics of the flash memory and the results obtained from reliability testing by Renesas Electronics Corporation.
 4. This temperature is the average value at which data are retained.

3.9 Dedicated Flash Memory Programmer Communication (UART)

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq V_{DD0} = V_{DD1} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = V_{SS0} = V_{SS1} = 0\text{ V}$)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|---------------|--------|---------------------------|---------|------|-----------|------|
| Transfer rate | | During serial programming | 115,200 | | 1,000,000 | bps |

4.10 52-pin Products

R5F100JCAFA, R5F100JDFA, R5F100JEFA, R5F100JFAFA, R5F100JGAFA, R5F100JHAFA, R5F100JJFA, R5F100JKFA, R5F100JLAFA
 R5F101JCAFA, R5F101JDFA, R5F101JEFA, R5F101JFAFA, R5F101JGAFA, R5F101JHAFA, R5F101JJFA, R5F101JKFA, R5F101JLAFA
 R5F100JCDA, R5F100JDDFA, R5F100JEDFA, R5F100JFDFA, R5F100JGDFA, R5F100JHDA, R5F100JDDFA, R5F100JKDA, R5F100JLDA
 R5F101JCDA, R5F101JDDFA, R5F101JEDFA, R5F101JFDFA, R5F101JGDFA, R5F101JHDA, R5F101JDDFA, R5F101JKDA, R5F101JLDA
 R5F100JCGFA, R5F100JDGFA, R5F100JEGFA, R5F100JFGFA, R5F100JGGFA, R5F100JHGFA, R5F100JJGFA

| JEITA Package Code | RENESAS Code | Previous Code | MASS (TYP.) [g] |
|---------------------|--------------|----------------|-----------------|
| P-LQFP52-10x10-0.65 | PLQP0052JA-A | P52GB-65-GBS-1 | 0.3 |

